

FAST TURN-OFF THYRISTORS

A range of fast turn-off thyristors in metal envelopes, intended for use in inverter applications. The series consists of reverse polarity types (anode to stud) identified by a suffix R: BTW33-800R to 1200R.

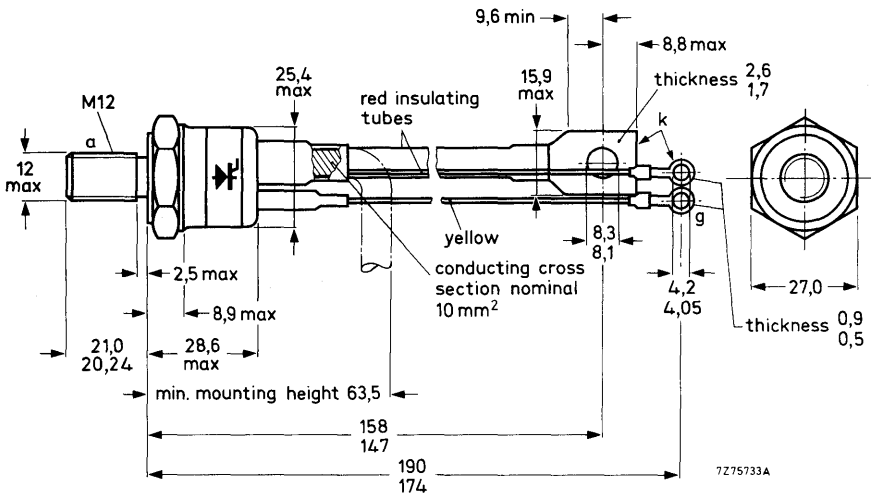
QUICK REFERENCE DATA

	V_{DRM}/V_{RRM}	BTW33-800R	1000R	1200R
		max.	800	1000
Repetitive peak voltages				
Average on-state current		$I_{T(AV)}$	max. 80 A	
R.M.S. on-state current		$I_{T(RMS)}$	max. 110 A	
Non-repetitive peak on-state current		I_{TSM}	max. 1500 A	
Circuit-commutated turn-off time		t_q	< 25 μs	

MECHANICAL DATA

Dimensions in mm

Fig. 1 TO-94; with metric M12 stud (ϕ 12 mm)



Net mass: 108 g
 Diameter of clearance hole: max. 13,0 mm
 Torque on nut: min. 9 Nm (90 kg cm)
 max. 17,5 Nm (175 kg cm)

Supplied with device: 1 nut, 1 lock washer
 Nut dimensions across the flats;
 M12: 19 mm

RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

Anode to cathode

		BTW33-800R	1000R	1200R
Non-repetitive peak voltages ($t \leq 10$ ms)	V_{DSM}^{**}/V_{RSM}	max. 800	1000	1200 V
Repetitive peak voltages	V_{DRM}/V_{RRM}	max. 800	1000	1200 V▲
Crest working off-state voltage square-wave; $\delta = 0,5$	V_{DWM}	max. 600	800	1000 V *
Average on-state current assuming zero switching losses (averaged over any 20 ms period)				
square-wave; $\delta = 0,5$; up to $T_{mb} = 70$ °C	$I_T(AV)$		max.	80 A
square-wave; $\delta = 0,5$; at $T_{mb} = 85$ °C	$I_T(AV)$		max.	65 A
sinusoidal; at $T_{mb} = 85$ °C	$I_T(AV)$		max.	60 A
R.M.S. on-state current	$I_T(RMS)$		max.	110 A
Repetitive peak on-state current	I_{TRM}		max.	750 A
Non-repetitive peak on-state current				
$T_j = 125$ °C prior to surge				
$t = 10$ ms; half sine-wave (see Fig. 8)	I_{TSM}		max.	1500 A
$t = 5$ ms; square pulse (see Fig. 7)	I_{TSM}		max.	1500 A
I^2t for fusing ($t = 10$ ms)	I^2t		max.	11 250 A ² s
Rate of rise of on-state current after triggering with $I_G = 750$ mA to $I_T = 200$ A; $dI_G/dt = 1$ A/ μ s	dI_T/dt		max.	100 A/ μ s
Gate to cathode				
Reverse peak voltage	V_{RGM}		max.	10 V
Average power dissipation (averaged over any 20 ms period)	$P_G(AV)$		max.	2 W
Peak power dissipation	P_{GM}		max.	10 W
	T_{stg}			-55 to + 125 °C
Temperatures				
Storage temperature	T_{stg}			-55 to + 125 °C
Junction temperature	T_j		max.	125 °C

THERMAL RESISTANCE

From junction to mounting base	$R_{th j-mb}$	=	0,3 °C/W
From mounting base to heatsink	$R_{th mb-h}$	=	0,1 °C/W
Transient thermal impedance ($t = 1$ ms)	$Z_{th j-mb}$	=	0,015 °C/W

* To ensure thermal stability: $R_{th j-a} < 0,75$ °C/W (d.c. blocking) or $< 1,5$ °C/W (square-wave; $\delta = 0,5$). For smaller heatsinks $T_{j max}$ should be derated. For square-wave see Fig. 6.

** Although not recommended, higher off-state voltages may be applied without damage, but the thyristor may switch into the on-state. The rate of rise of on-state current should not exceed 20 A/ μ s.

▲ Thermal stability at higher voltage ratings is dependent on duty factor. See Figs 19 and 20.

CHARACTERISTICS

Anode to cathode

On-state voltage

$I_T = 200 \text{ A}; T_j = 25 \text{ }^\circ\text{C}$

$V_T < 3 \text{ V}^*$

Rate of rise of off-state voltage that will not trigger

any device; exponential method; $V_D = 2/3 V_{DRMmax}$;

$T_j = 125 \text{ }^\circ\text{C}$

$dV_D/dt < 200 \text{ V}/\mu\text{s}$

Off-state current

$V_D = V_{DWMmax}; T_j = 125 \text{ }^\circ\text{C}$

$I_D < 25 \text{ mA}$

Holding current; $T_j = 25 \text{ }^\circ\text{C}$

$I_H < 200 \text{ mA}$

Latching current; $T_j = 25 \text{ }^\circ\text{C}$

$I_L < 400 \text{ mA}$

Gate to cathode

Voltage that will trigger all devices

$V_D = 6 \text{ V}; T_j = 25 \text{ }^\circ\text{C}$

$V_{GT} > 2,5 \text{ V}$

Voltage that will not trigger any device

$V_D = V_{DRMmax}; T_j = 125 \text{ }^\circ\text{C}$

$V_{GD} < 0,2 \text{ V}$

Current that will trigger all devices

$V_D = 6 \text{ V}; T_j = 25 \text{ }^\circ\text{C}$

$I_{GT} > 150 \text{ mA}$

Switching characteristics

Gate-controlled turn-on time ($t_{gt} = t_d + t_r$) when switched from $V_D = V_{DWMmax}$ to $I_T = 200 \text{ A}$;

$I_{GT} = 200 \text{ mA}; dI_G/dt = 1 \text{ A}/\mu\text{s}; T_j = 25 \text{ }^\circ\text{C}$

$t_d < 2 \mu\text{s}$

$t_r < 2 \mu\text{s}$

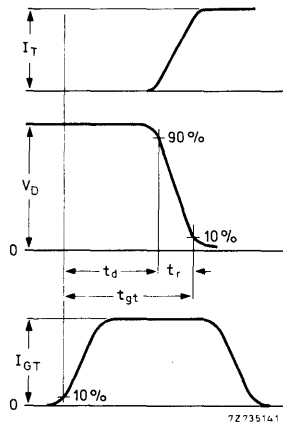


Fig. 2 Gate-controlled turn-on time definitions.

* Measured under pulse conditions to avoid excessive dissipation.

CHARACTERISTICS (continued)

Circuit-commutated turn-off time when switched
 from $I_T = 50$ A to $V_R \geq 50$ V with $-dI_T/dt = 50$ A/ μ s;
 $dV_D/dt = 25$ V/ μ s; $T_j = 125$ °C

$$t_q < 25 \mu\text{s}$$

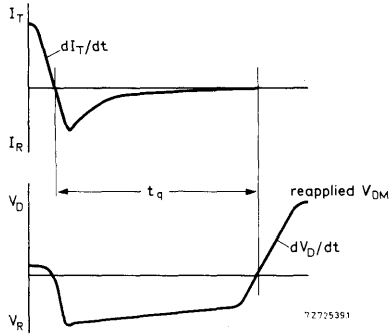


Fig. 3 Circuit-commutated turn-off time definitions.

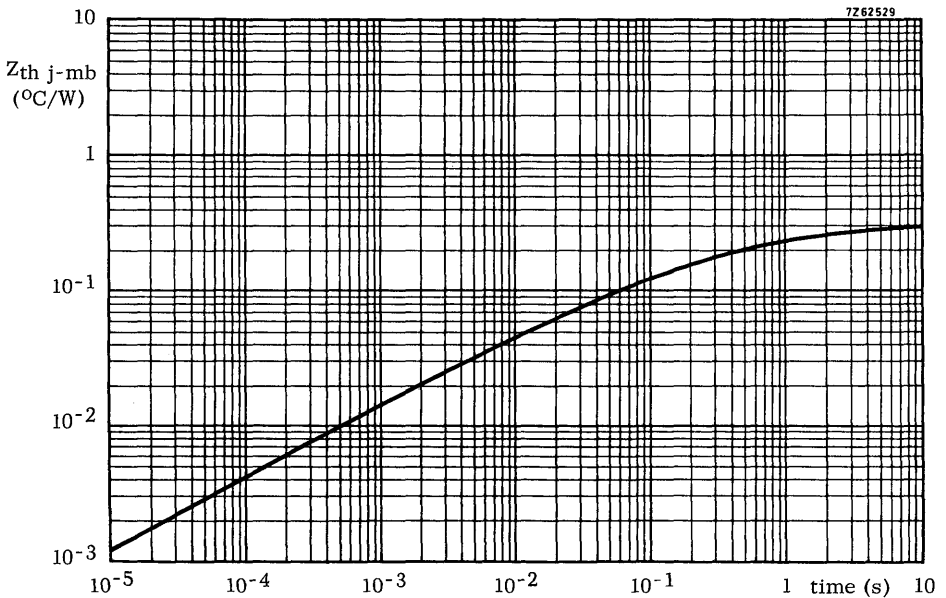


Fig. 4.

P = dissipation excluding switching losses

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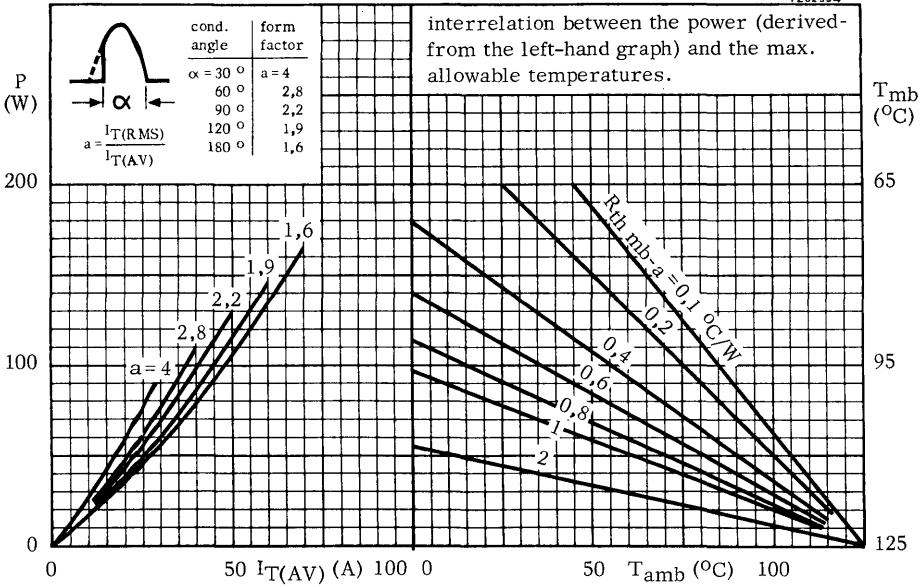
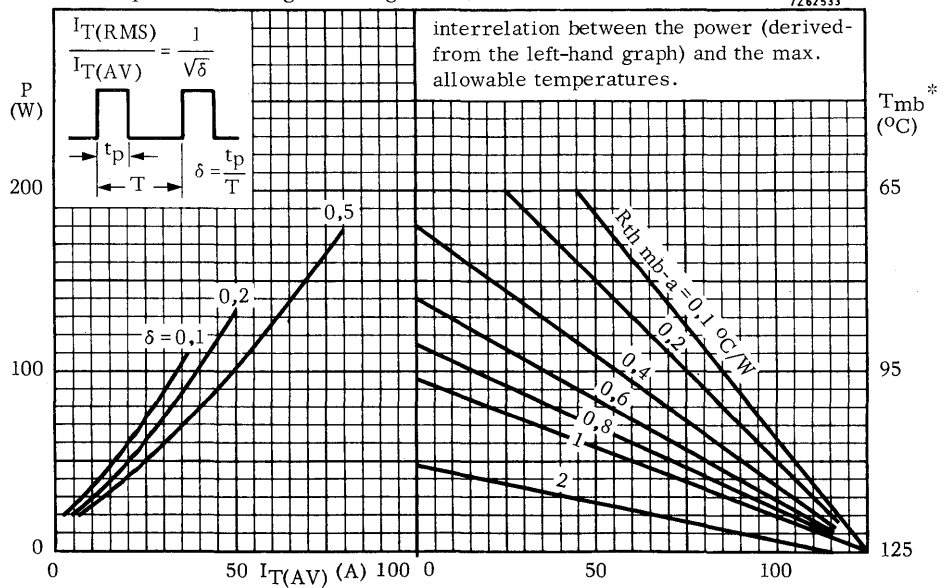


Fig. 5.

P = dissipation excluding switching losses

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* T_{mb} -scale is for comparison purposes only and is correct only for $R_{th\ mb-a} \leq 1,0\ ^\circ C/W$.

Fig. 6.

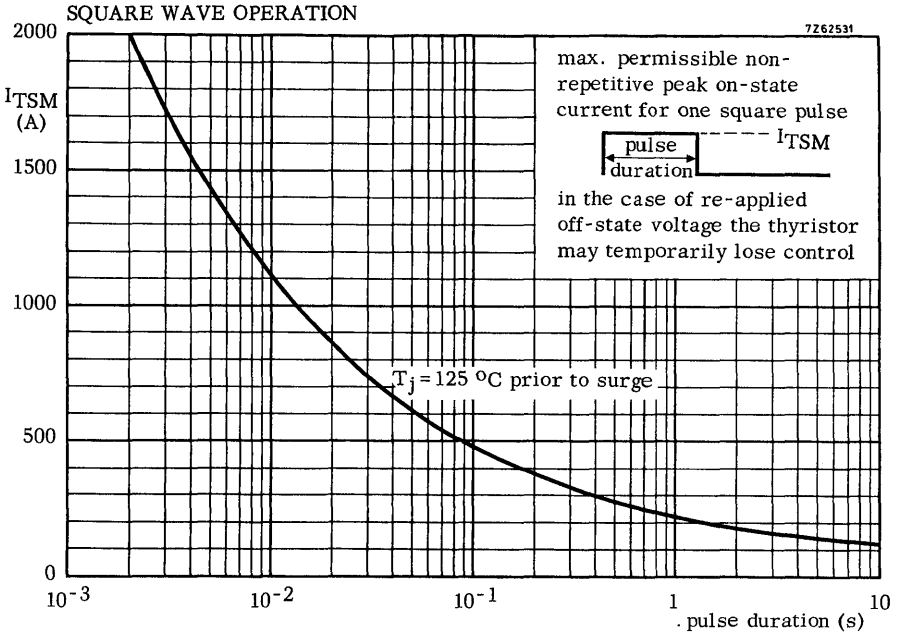


Fig. 7.

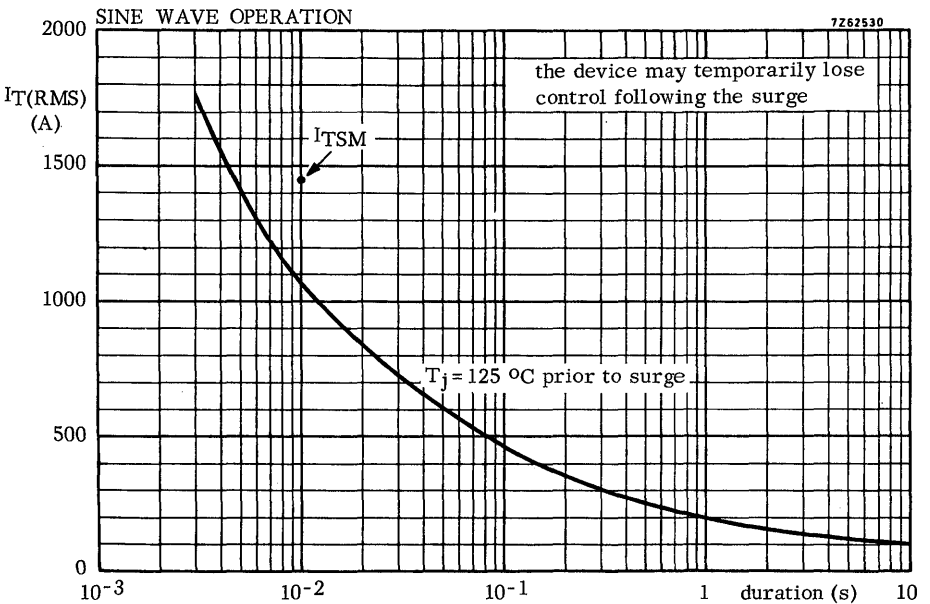


Fig. 8.

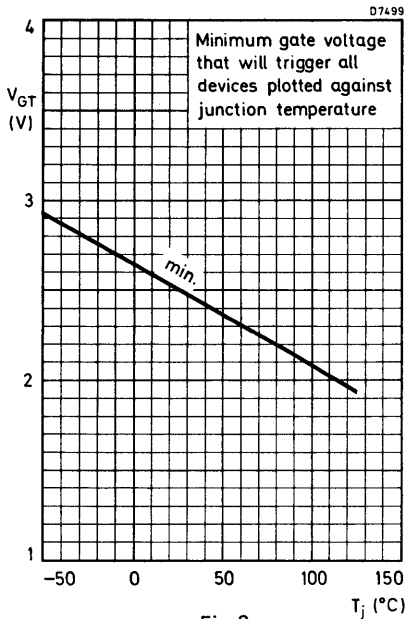


Fig. 9.

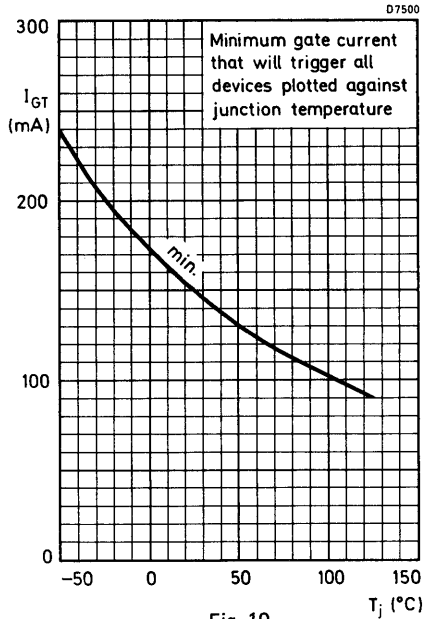


Fig. 10.

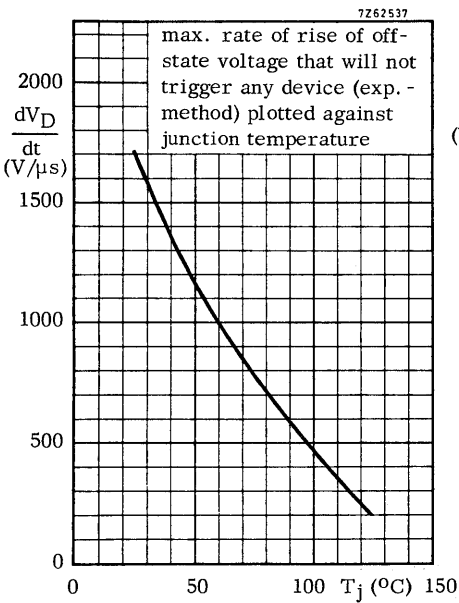


Fig. 11.

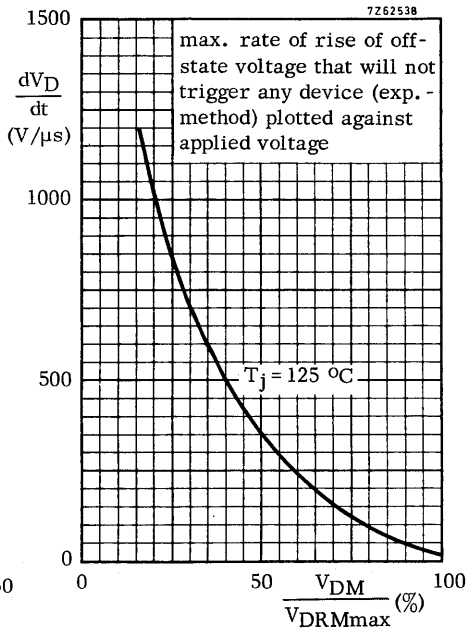
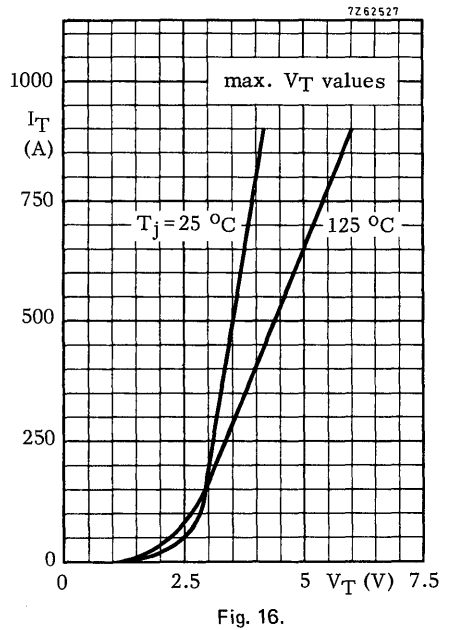
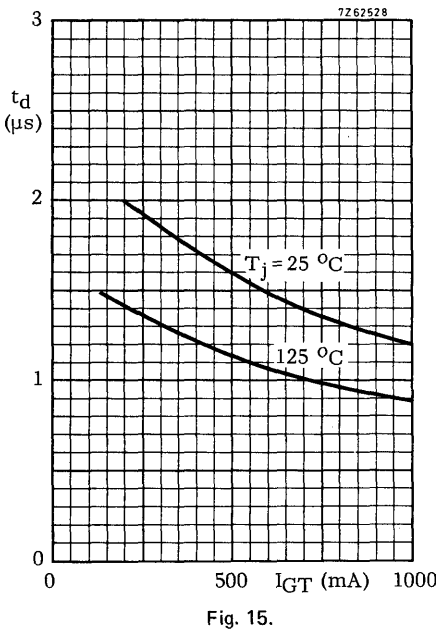
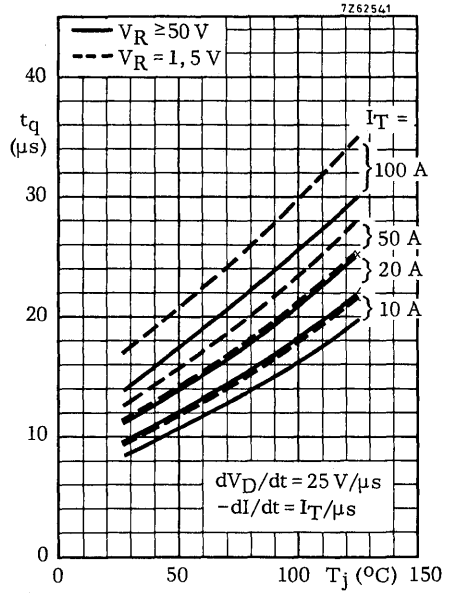
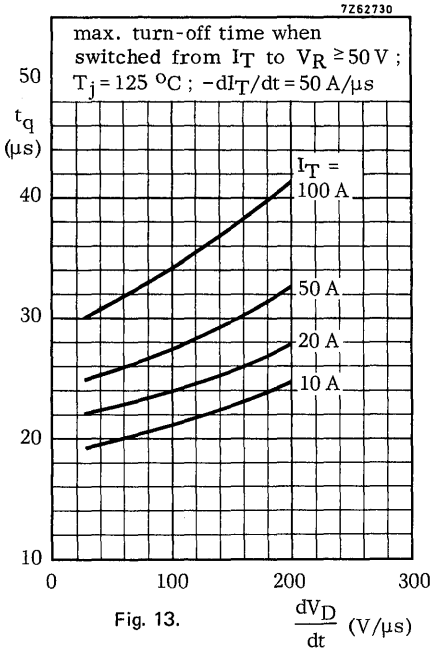


Fig. 12.



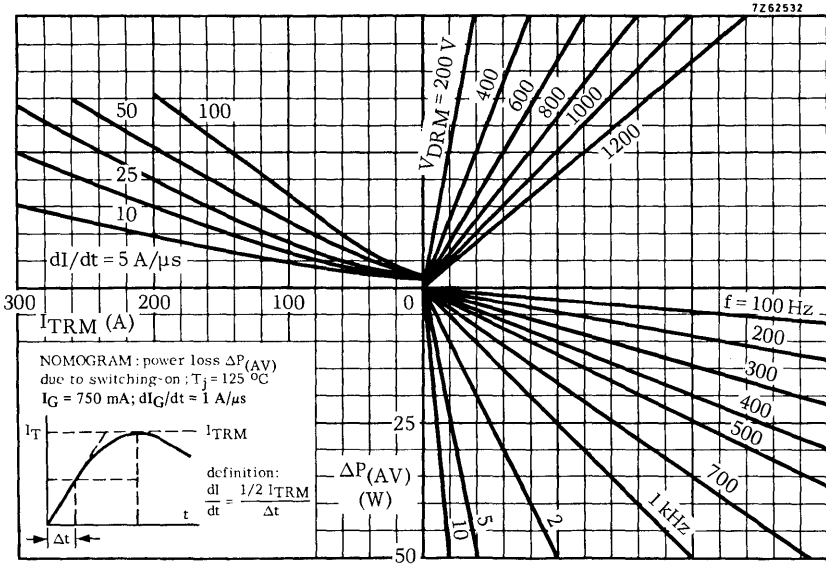


Fig. 17.

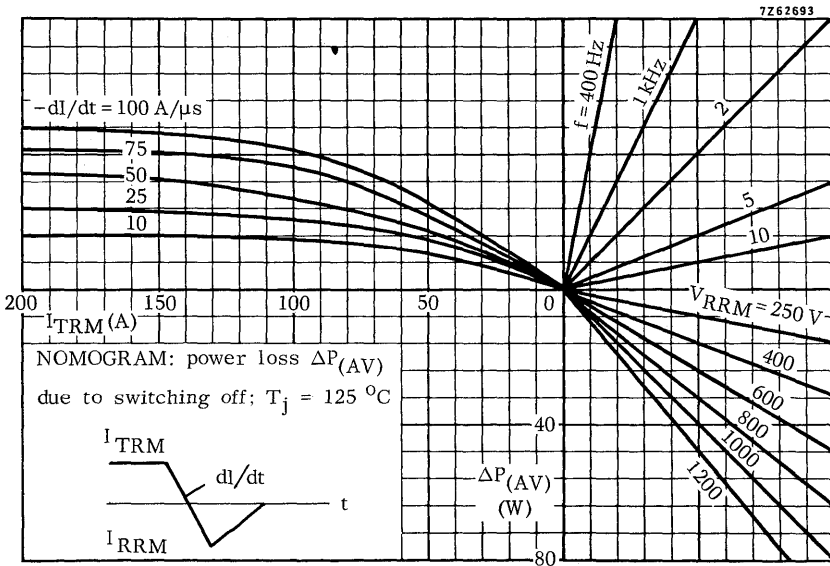


Fig. 18.

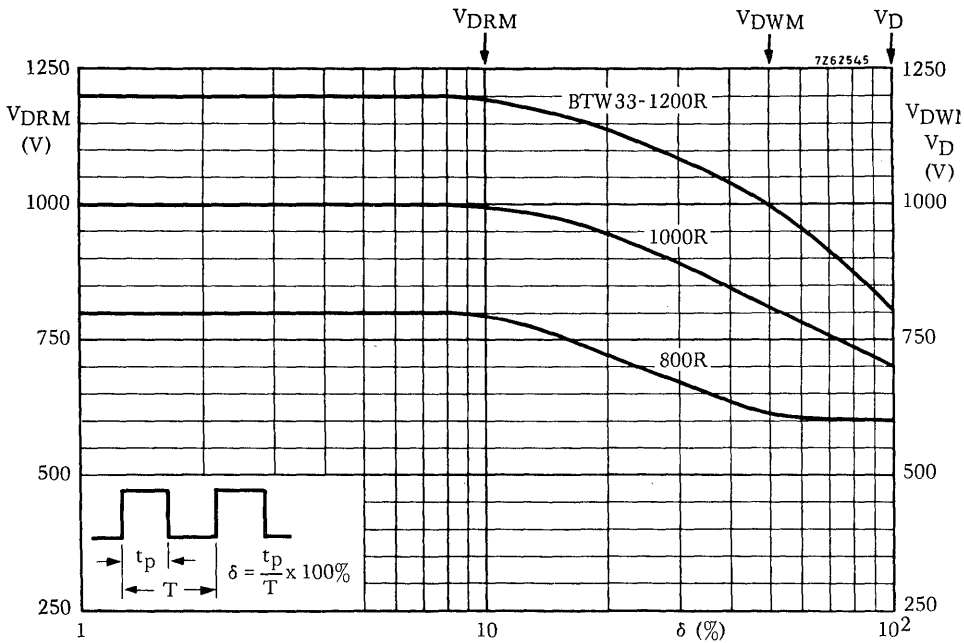


Fig. 19.

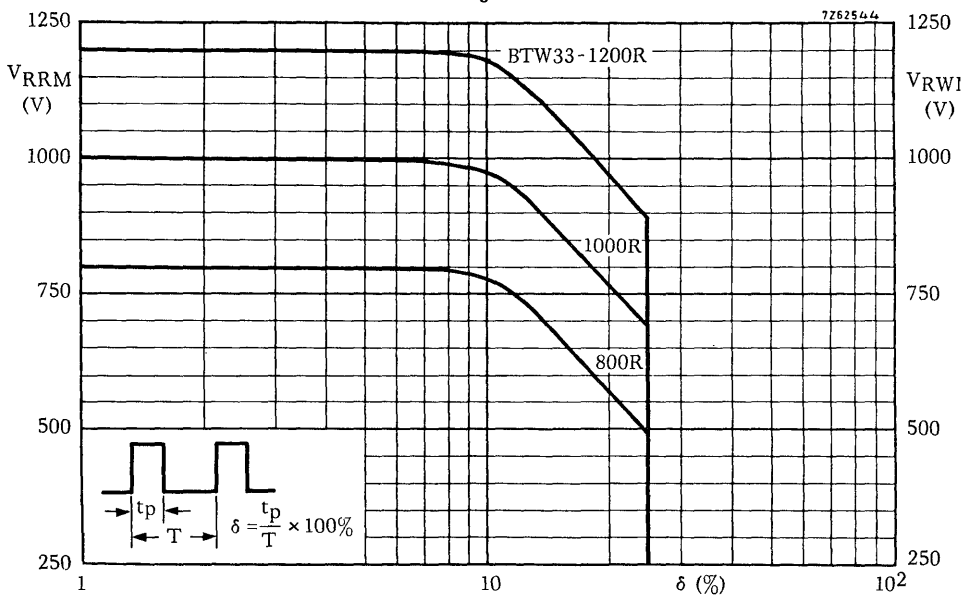


Fig. 20.